

22. [Amended Once] A system for making a thin-film device, the system comprising:
a substrate-supply station that supplies a substrate having a major surface area;
a plurality of deposition stations that deposit layers onto the substrate including a first deposition station and a second deposition station, wherein the first and the second deposition stations each supply [supplies] energy to the layer to aid in crystalline layer formation while controlling a stoichiometry of the respective crystalline layers without substantially heating the substrate.
23. [Amended Once] The system [for making a thin-film device] of claim 22 wherein the substrate-supply station supplies a continuous plastic sheet.
24. [Amended Once] The system [for making a thin-film device] of claim 22 wherein the substrate-supply station supplies a continuous set of wafers.
25. [Amended Once] The system [for making a thin-film device] of claim 22 wherein the plurality of deposition stations deposit a thin film battery.
26. [Amended Once] The system [for making a thin-film device] of claim 22 wherein the plurality of deposition stations deposits a capacitor.
27. [Amended Once] The system [for making a thin-film device] of claim 22 wherein the plurality of deposition stations deposits a thin film battery and a device powered by the thin film battery.
28. [Amended Once] The system [for making a thin-film device] of claim 22 wherein the plurality of deposition stations deposit a thin film battery and a device powered by the thin film battery, wherein the device is deposited onto the thin film battery.
29. [Amended Once] The system [for making a thin-film device] of claim 22 wherein the

plurality of deposition stations deposit a thin film battery and a set of traces for electrically connecting a device to the thin film battery.

30. [Amended Once] The system [for making a thin-film device] of claim 29 further comprising a placement device for placing components onto the traces.

31. [Amended Once] The system [for making a thin-film device] of claim 22 wherein the at least one deposition station deposits an energy-conversion device.

32. [New] The system of claim 11, wherein the second layer is a LiCoO_2 intercalation material, and the ion-assist includes ionized oxygen that combines with LiCo to form the LiCoO_2 intercalation material.

33. [New] The system according to claim 11, further comprising
 a second substrate-supply station that supplies a substrate having a major surface area;
 a second deposition station that deposits the first layer onto the substrate, wherein the second deposition station supplies ion-assist energy to the first layer to aid in crystalline layer formation while controlling a stoichiometry of the crystalline layer without substantially heating the substrate.

34. [New] A system for making a thin-film device, the system comprising:
 a first substrate-supply station that supplies a substrate having a major surface area, the substrate having a first layer, having a composition different than the substrate, formed on a first surface area of the substrate's major surface area;
 a first deposition station that deposits a second layer onto the first layer, wherein the first deposition station supplies an amount of ion-assist energy to the second layer to aid in crystalline layer formation while controlling a stoichiometry of the crystalline layer without substantially heating the substrate, wherein the substrate is a flexible material supplied from a roll, and the first and second layers are deposited on the substrate while the substrate moves in a continuous

motion, wherein the first and second layer forms a cathode layer of a battery including the cathode layer; an anode layer, and an electrolyte layer located between and electrically isolating the anode layer from the cathode layer, wherein the anode or the cathode or both include an intercalation material.

35. [New] The system according to claim 34, further comprising a second deposition station that deposits an electrical circuit layer on the battery.

36. [New] The system according to claim 34, wherein the substrate is a polymer material having a melting point below about 700 degrees Celsius.

37. [New] The system according to claim 34, wherein the energizing of the second layer includes supplying ions of at least 5eV.

38. [New] The system according to claim 34, wherein the substrate is a polymer material having a melting point below about 700 degrees Celsius, and wherein the energizing of the second layer includes supplying ions of at least 5eV.

39. [New] The system according to claim 21, wherein the substrate-supply station supplies a continuous plastic sheet.

40. [New] The system according to claim 21, wherein the substrate-supply station supplies a sequential set of wafers.

41. [New] The system according to claim 21, wherein the means deposit a thin film battery.